

Title (en)
Method and device for splicing webs

Title (de)
Verfahren und Vorrichtung zum Verbinden von Materialbahnen

Title (fr)
Méthode et dispositif pour le raccordement de bandes

Publication
EP 0940360 A3 20000830 (DE)

Application
EP 99100542 A 19990113

Priority
DE 19804614 A 19980206

Abstract (en)
[origin: EP1340702A1] The preceding web (29) on the one hand and the new web on the other hand are clamped and from the preceding web and from the new web a commencement piece and an end piece are separated. The thus formed ends are positioned next to each other in a common plane for connection and application of the tape. To form the commencement piece of the new web, a closed outer casing of a new bobbin and a closed outer layer of a new web are separated in an axial direction so that at least a free web leg of the new web hangs freely by its own weight, the web leg is secured and a commencement piece of the new bobbin (30) is drawn away.

IPC 1-7
B65H 19/18

IPC 8 full level
B65H 19/10 (2006.01); **B65H 19/18** (2006.01); **B65H 21/00** (2006.01); **B65H 23/188** (2006.01)

CPC (source: EP KR US)
B65H 19/105 (2013.01 - EP US); **B65H 19/107** (2013.01 - EP US); **B65H 19/1852** (2013.01 - EP US); **B65H 19/1868** (2013.01 - EP US); **B65H 21/00** (2013.01 - KR); **B65H 23/1886** (2013.01 - EP US); **B65H 2301/415095** (2013.01 - EP US); **B65H 2301/46115** (2013.01 - EP US); **B65H 2301/46176** (2013.01 - EP US); **B65H 2301/4622** (2013.01 - EP US); **B65H 2301/4631** (2013.01 - EP US); **B65H 2403/51** (2013.01 - EP US); **B65H 2406/341** (2013.01 - EP US); **B65H 2406/342** (2013.01 - EP US); **B65H 2801/54** (2013.01 - EP US); **B65H 2801/81** (2013.01 - EP US)

Citation (search report)

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Designated contracting state (EPC)
AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE

DOCDB simple family (publication)
US 6142408 A 20001107; AT E335690 T1 20060915; BR 9900617 A 19991214; CN 1160234 C 20040804; CN 1225330 A 19990811; DE 19804614 A1 19990812; DE 59910156 D1 20040916; DE 59913766 D1 20060921; EP 0940360 A2 19990908; EP 0940360 A3 20000830; EP 0940360 B1 20040811; EP 1340702 A1 20030903; EP 1340702 B1 20060809; EP 1340702 B8 20100707; ES 2226208 T3 20050316; JP 2007039251 A 20070215; JP 3905240 B2 20070418; JP 4202382 B2 20081224; JP H11268853 A 19991005; KR 19990072462 A 19990927

DOCDB simple family (application)
US 24570899 A 19990208; AT 03006338 T 19990113; BR 9900617 A 19990205; CN 99101778 A 19990205; DE 19804614 A 19980206; DE 59910156 T 19990113; DE 59913766 T 19990113; EP 03006338 A 19990113; EP 99100542 A 19990113; ES 99100542 T 19990113; JP 2006309033 A 20061115; JP 3044499 A 19990208; KR 19990004075 A 19990206